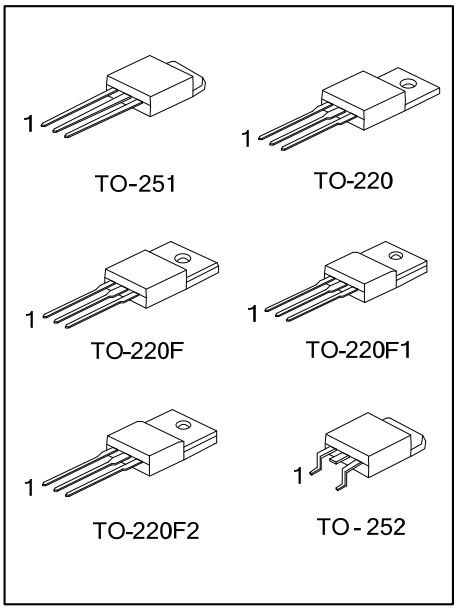
1.0A, 700V N-CHANNEL POWER MOSFET



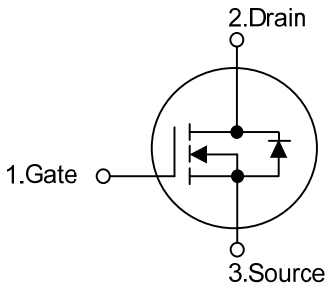
■ DESCRIPTION

The UTC **1N70-CB** is a high voltage MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

■ FEATURES

* $R_{DS(ON)}$ < 12Ω @ V_{GS} = 10V , I_D = 0.5A
* Fast switching capability
* Avalanche energy specified
* Improved dv/dt capability, high ruggedness

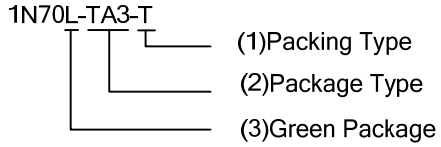
■ SYMBOL



■ ORDERING INFORMATION

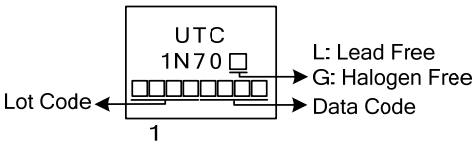
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
1N70L-TA3-T	1N70G-TA3-T	TO-220	G	D	S	Tube
1N70L-TF1-T	1N70G-TF1-T	TO-220F1	G	D	S	Tube
1N70L-TF2-T	1N70G-TF2-T	TO-220F2	G	D	S	Tube
1N70L-TF3-T	1N70G-TF3-T	TO-220F	G	D	S	Tube
1N70L-TM3-T	1N70G-TM3-T	TO-251	G	D	S	Tube
1N70L-TN3-R	1N70G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



(1) T: Tube, R: Tape Reel
(2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F, TM3: TO-251, TN3: TO-252
(3) L: Lead Free, G: Halogen Free and Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I_D	1.0	A
	Pulsed (Note 2)	I_{DM}	4.0	A
Avalanche Current (Note 2)		I_{AR}	1.5	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	11	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.6	V/ns
Power Dissipation	TO-220	P_D	40	W
	TO-220F/TO-220F1 TO-220F2		21	W
	TO-251/TO-252		28	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. L=10mH, I_{AS}=1.5A, V_{DD}=50V, R_G=25 Ω, Starting T_J = 25°C
4. I_{SD}≤1.0A, di/dt≤200A/μs, V_{DD}≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

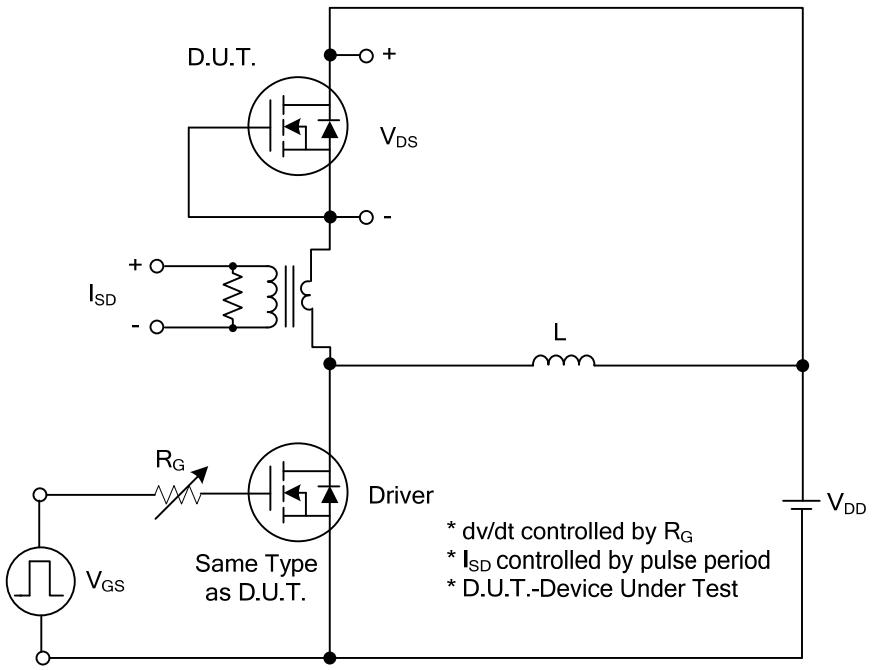
PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	θ_{JA}	62.5	°C/W
	TO-251/TO-252		110	°C/W
Junction to Case	TO-220	θ_{JC}	3.13	°C/W
	TO-220F/TO-220F1 TO-220F2		5.95	°C/W
	TO-251/TO-252		4.46	°C/W

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

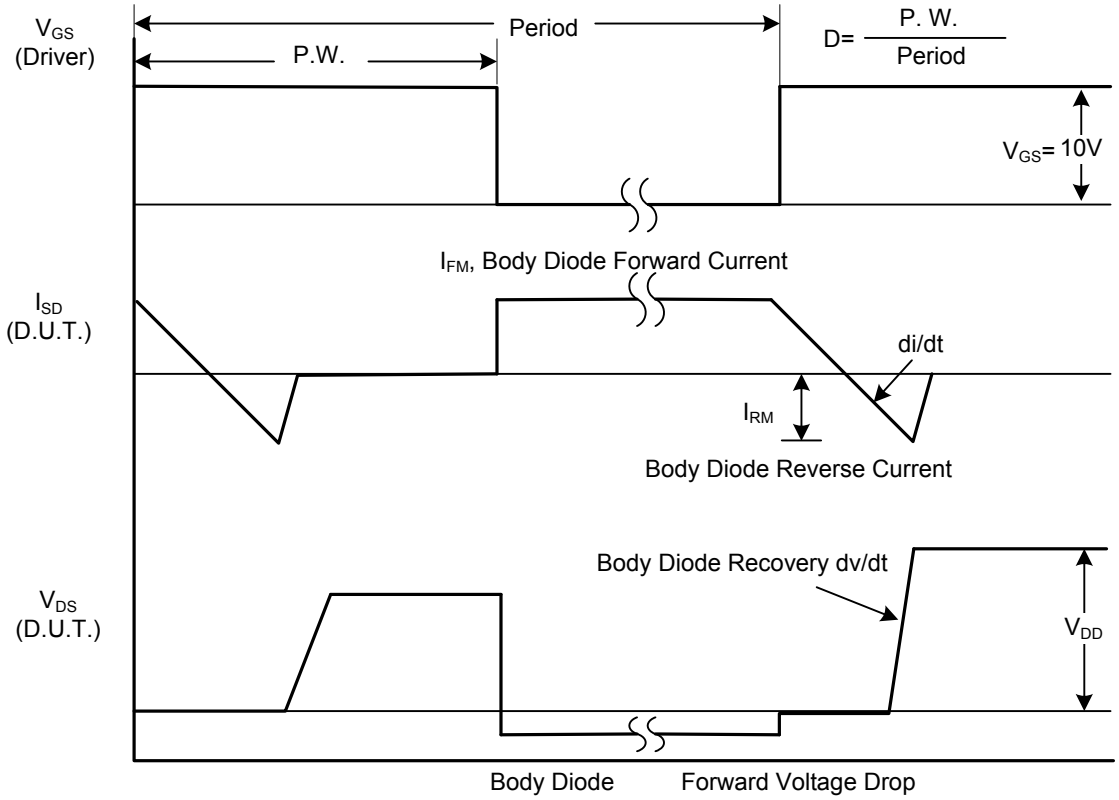
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS} = 0V, I_D = 250μA	700			V
Drain-Source Leakage Current		I_{DSS}	V_{DS} = 700V, V_{GS} = 0V			1	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS} = 30V, V_{DS} = 0V			100	nA
	Reverse		V_{GS} = -30V, V_{DS} = 0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS} = V_{GS}, I_D = 250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS} = 10V, I_D =0.5A			12	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	V_{DS} =25V, V_{GS} =0V, f =1MHz		195		pF
Output Capacitance		C_{OSS}			29		pF
Reverse Transfer Capacitance		C_{RSS}			15		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)		Q_G	V_{DS}=50V, V_{GS}=10V, I_D=0.83A I_G=100μA (Note 1, 2)		18		nC
Gate to Source Charge		Q_{GS}			1.7		nC
Gate to Drain Charge		Q_{GD}			1.7		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	V_{DS}=30V, V_{GS}=10V, I_D=0.5A, R_G =25Ω (Note 1, 2)		36		ns
Rise Time		t_R			14		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			78		ns
Fall-Time		t_F			12		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_{SD}				1.0	A
Maximum Body-Diode Pulsed Current		I_{SM}				4.0	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S=1.0A, V_{GS}=0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	I_S=1.0A, V_{GS}=0V, dI_F/dt=100A/μs		250		nS
Body Diode Reverse Recovery Charge		Q_{rr}			0.43		μC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle≤2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

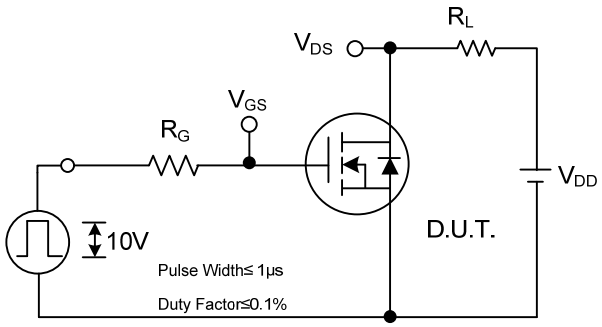


Peak Diode Recovery dv/dt Test Circuit

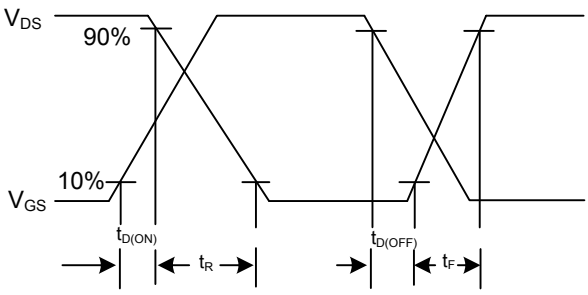


Peak Diode Recovery dv/dt Waveforms

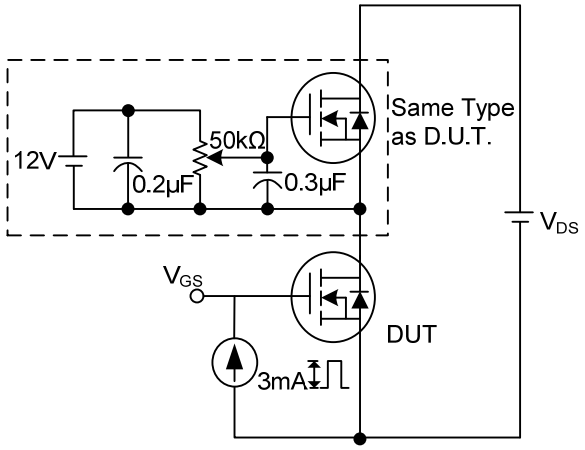
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



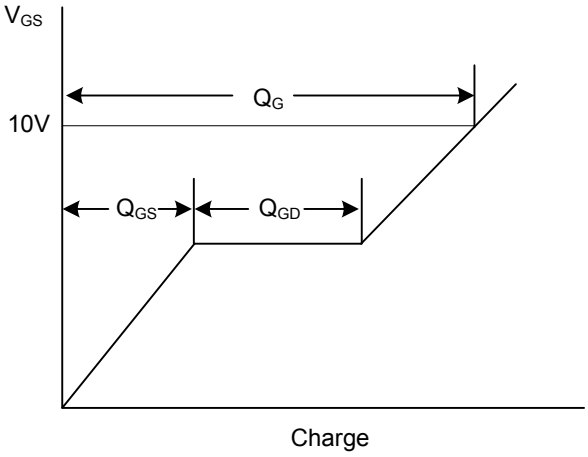
Switching Test Circuit



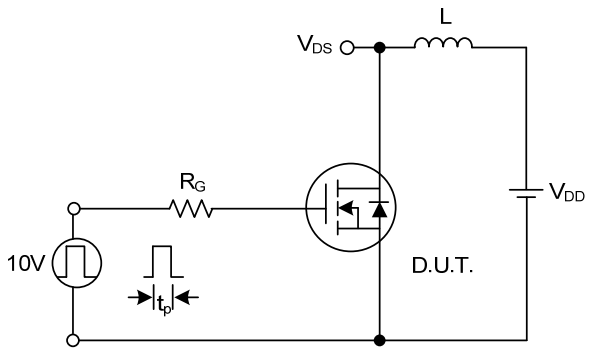
Switching Waveforms



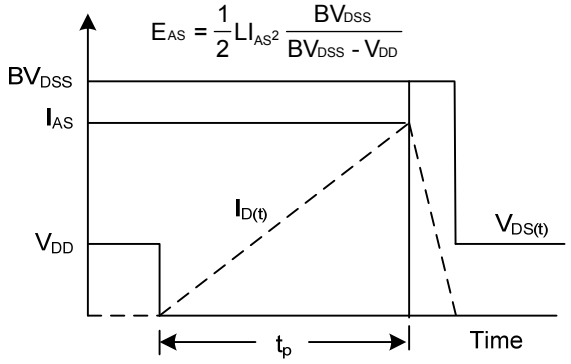
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms